

ROHS

HALOGEN FREE

# Hyperfast Rectifier, 30 A FRED Pt® G5



#### **LINKS TO ADDITIONAL RESOURCES**





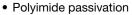
PRIMARY CHARACTERISTICS						
I <sub>F(AV)</sub>	30 A					
V <sub>R</sub>	1200 V					
V <sub>F</sub> at I <sub>F</sub> at 125 °C	2.1 V					
t <sub>rr</sub>	26 ns					
T <sub>J</sub> max.	175 °C					
Package	TO-247AD 2L					
Circuit configuration	Single					

#### **FEATURES**

- Hyperfast and optimized Q<sub>rr</sub>
- Best in class forward voltage drop and switching losses trade off







 Material categorization: for definitions of compliance please see <a href="https://www.vishav.com/doc?99912">www.vishav.com/doc?99912</a>

### **DESCRIPTION / APPLICATIONS**

Featuring a unique combination of low conduction and switching losses, this rectifier is the right choice for high frequency converters, both soft switched / resonant. Specifically designed to improve efficiency of PFC and output rectification stages of EV / HEV battery charging stations, booster stage of solar inverters and UPS applications, these devices are perfectly matched to operate with MOSFETs or high speed IGBTs.

#### **MECHANICAL DATA**

Case: TO-247AD 2L

Molding compound meets UL 94 V-0 flammability rating **Terminals**: matte tin plated leads, solderable per

J-STD-002

ABSOLUTE MAXIMUM RATINGS							
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS			
Repetitive peak reverse voltage	$V_{RRM}$		1200	V			
Average rectified forward current	I <sub>F(AV)</sub>	T <sub>C</sub> = 105 °C, D = 0.50	30				
Non-repetitive peak surge current	I <sub>FSM</sub>	$T_C = 45$ °C, $t_p = 10$ ms, sine wave	210	Α			
Repetitive peak forward current	I <sub>FRM</sub>	$T_C = 105 ^{\circ}C, D = 0.50, f = 20 \text{kHz}$	60				
Operating junction and storage temperature	T <sub>J</sub> , T <sub>Stg</sub>		-55 to +175	°C			

<b>ELECTRICAL SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)								
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS		
Breakdown voltage, blocking voltage	$V_{BR}, V_{R}$	I <sub>R</sub> = 100 μA	1200	-	-			
Forward voltage	V <sub>F</sub>	I <sub>F</sub> = 30 A	-	2.6	3.15	V		
		I <sub>F</sub> = 30 A, T <sub>J</sub> = 125 °C	-	2.1	=.			
De construir de la construir d	I <sub>R</sub>	V <sub>R</sub> = V <sub>R</sub> rated	-	-	50	μА		
Reverse leakage current		T <sub>J</sub> = 125 °C, V <sub>R</sub> = V <sub>R</sub> rated	-	-	500			
Junction capacitance	C <sub>T</sub>	V <sub>R</sub> = 200 V	-	17	-	pF		
Series inductance	L <sub>S</sub>	Measured to lead 5 mm from package body	ı	8	-	nH		



<b>DYNAMIC RECOVERY CHARACTERISTICS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
		$I_F = 1.0 \text{ A}, dI_F/dt = 100$	) A/μs, V <sub>R</sub> = 30 V	-	26	-	
Reverse recovery time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C		-	100	-	ns
		T <sub>J</sub> = 125 °C		-	150	-	
Dook roopyony ourrent		T <sub>J</sub> = 25 °C	$I_F = 20 \text{ A}$	-	12	-	A
Peak recovery current	I <sub>RRM</sub>	T <sub>J</sub> = 125 °C	$dI_F/dt = 600 \text{ A/}\mu\text{s}$ $V_R = 400 \text{ V}$	-	22	-	
Doverno recovery charge	0	T <sub>J</sub> = 25 °C		-	530	-	nC
Reverse recovery charge	Q <sub>rr</sub>	T <sub>J</sub> = 125 °C		-	1550	-	
Doverno recovery time	+	T <sub>J</sub> = 25 °C	$I_F = 30 \text{ A}$ $dI_F/dt = 1000 \text{ A/}\mu\text{s}$ $V_R = 800 \text{ V}$	-	80	-	ns
Reverse recovery time	t <sub>rr</sub>	T <sub>J</sub> = 125 °C		-	120	-	
Dools recovery comment		T <sub>J</sub> = 25 °C		-	22	-	А
Peak recovery current	I <sub>RRM</sub>	T <sub>J</sub> = 125 °C		-	37	-	
Reverse recovery charge		T <sub>J</sub> = 25 °C		-	900	-	nC
	Q <sub>rr</sub>	T <sub>J</sub> = 125 °C		-	2300		

THERMAL - MECHANICAL SPECIFICATIONS								
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS		
Thermal resistance, junction-to-case	$R_{thJC}$		-	-	0.8	°C/W		
Weight			-	5.5	-	g		
Mounting torque			6.0 (5.0)	-	12 (10)	kgf · cm (lbf · in)		
Maximum junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>		-55	-	175	°C		
Marking device		Case style: TO-247AD 2L	E5PX3012L					

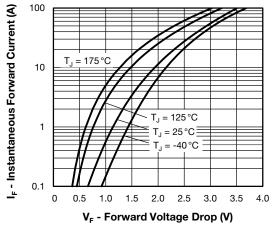


Fig. 1 - Typical Forward Voltage Drop Characteristics

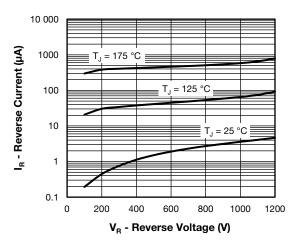


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

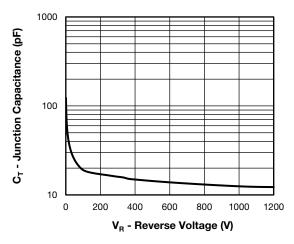


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

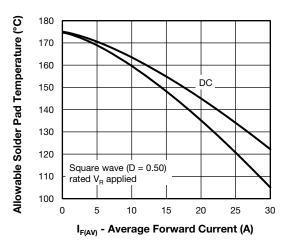


Fig. 4 - Maximum Allowable Case Temperature vs.
Average Forward Current

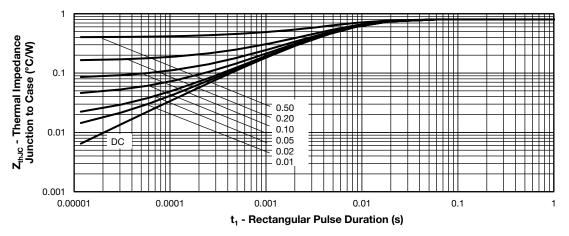


Fig. 5 - Thermal Impedance Z<sub>thJC</sub> Characteristics

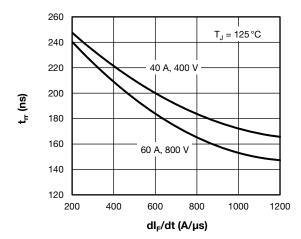


Fig. 6 - Typical Reverse Recovery Time vs.  $dI_F/dt$ 

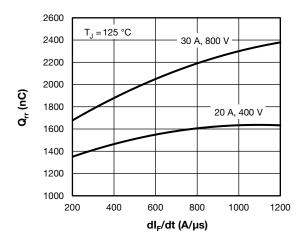


Fig. 7 - Typical Stored Charge vs. dl<sub>F</sub>/dt

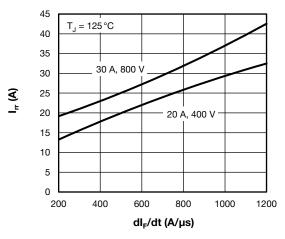


Fig. 8 - Typical Recovery Current vs. dl<sub>F</sub>/dt

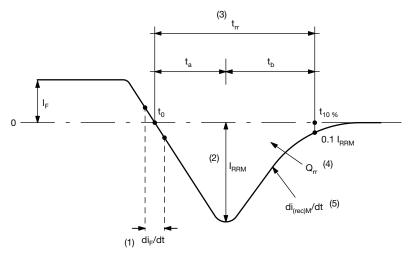


Fig. 9 - Reverse Recovery Waveform and Definitions

#### **Notes**

- (1) di<sub>F</sub>/dt rate of change of current through zero crossing
- (2) I<sub>RRM</sub> peak reverse recovery current
- $_{tr}$  reverse recovery time measured from  $t_0$ , crossing point of negative going  $I_F$ , to point  $t_{10\%}$ , 0.1  $I_{RRM}$
- $^{(4)}$   $\,$   $Q_{rr}$  area under curve defined by  $t_0$  and  $t_{10}\,\%$

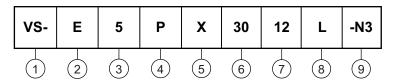
$$Q_{rr} = \int_{t_0}^{t_{10\%}} I(t)dt$$

 $$t_0$$ (5) $di_{(rec)}M/dt$  - peak rate of change of current during  $t_b$  portion of  $t_{rr}$ 



### **ORDERING INFORMATION TABLE**

**Device code** 



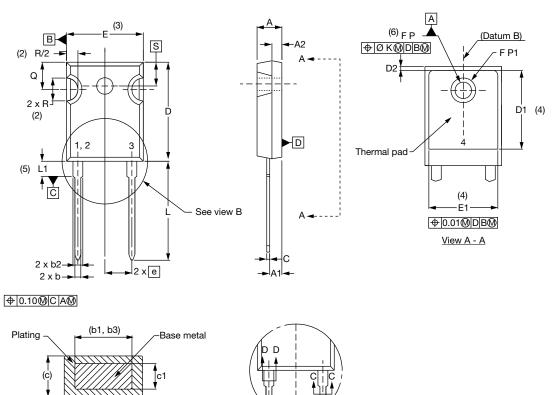
- Vishay Semiconductors product
- 2 E = single diode
- 3 5 = Fred generation 5
- 4 Package: P = TO-247 package
- 5 X = hyperfast recovery
- Current rating (30 = 30 A)
- 7 Voltage rating (12 = 1200 V)
- Package: L = long lead (TO-247AD)
- 9 Environmental digit:
  - -N3 = halogen-free, RoHS-compliant, and totally lead (Pb)-free

ORDERING INFORMATION (Example)							
PREFERRED P/N	QUANTITY PER TUBE	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION				
VS-E5PX3012L-N3	25	500	Antistatic plastic tube				

LINKS TO RELATED DOCUMENTS					
Dimensions	www.vishay.com/doc?95536				
Part marking information	www.vishay.com/doc?95648				
Spice model	www.vishay.com/doc?96684				

### **TO-247AD 2L**

### **DIMENSIONS** in millimeters and inches



View B

SYMBOL	MILLIN	MILLIMETERS		INCHES		
SYMBOL	MIN.	MAX.	MIN.	MAX.	NOTES	
А	4.65	5.31	0.183	0.209		
A1	2.21	2.59	0.087	0.102		
A2	1.50	2.49	0.059	0.098		
b	0.99	1.40	0.039	0.055		
b1	0.99	1.35	0.039	0.053		
b2	1.65	2.39	0.065	0.094		
b3	1.65	2.34	0.065	0.092		
С	0.38	0.89	0.015	0.035		
c1	0.38	0.84	0.015	0.033		
D	19.71	20.70	0.776	0.815	3	
D1	13.08	-	0.515	-	4	
D2	0.51	1.35	0.020	0.053		

Section C - C, D - D

SYMBOL	MILLIN	IETERS	INC	INCHES		
STWIBOL	MIN.	MAX.	MIN.	MAX.	NOTES	
Е	15.29	15.87	0.602	0.625	3	
E1	13.46	-	0.53	-		
е	5.46	BSC	0.215	BSC		
ØK	0.2	254	0.0	10		
L	19.81	20.32	0.780	0.800		
L1	3.71	4.29	0.146	0.169		
ØΡ	3.56	3.66	0.14	0.144		
Ø P1	-	6.98	-	0.275		
Q	5.31	5.69	0.209	0.224		
R	4.52	5.49	0.178	0.216		
S	5.51 BSC		0.217	BSC		
	•		•	•		

#### **Notes**

- (1) Dimensioning and tolerancing per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. These dimensions are measured at the outermost extremes of the plastic body
- (4) Thermal pad contour optional with dimensions D1 and E1
- (5) Lead finish uncontrolled in L1
- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- (7) Outline conforms to JEDEC® outline TO-247 with exception of dimension A min., D, E min., Q min., S, and note 4



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